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101778966

PATENTS ONLY

07/09/01

Attorney Docket No.: 040894-5689

To the Commissioner for Patents:
Please record the attached original documents or copy thereof.

ATTN: BOX ASSIGNMENT

1. Name of conveying party(ies):

1. Masaki YONEDA

Additional name(s) of conveying party(ies) attached?

Yes No

12/2001 ABOONE1 00000013 09900151

FC:381

40.00 DP

2. Name and address of receiving party(ies):

Name: ROHM CO., LTD.

Internal Address:



Street Address: 21, Saiin-Mizosaki-cho, Ukyo-ku,
Kyoto-shi, Kyoto, Japan

City:

State:

Zip:

Additional name(s) & address(es) attached?

Yes No

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: June 29, 2001

4. Application number(s) or patent number(s): **NEW APPLICATION**

09/900151

If this document is being filed together with a new application the execution date of the application is:

June 29, 2001

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached: Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Robert J. Gaybrick
Internal Address: Morgan, Lewis & Bockius LLP
Customer No. 009629
Street Address: 1800 M Street, N.W.
City: Washington State: D.C. Zip: 20036

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R §3.41): \$40.00
 Enclosed
 Authorized to be charged to deposit account 50-0310

8. Deposit account number: 50-0310
Attach duplicate of page if paying by deposit account

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert J. Goodell
Name of Person Signing

Robert J. Goodell Reg. No. 41,040
Signature

July 9, 2001
Date

Total number of pages including cover sheet, attachments and documents: 2

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

CHIP RESISTOR

for which I/WE executed an application for United States Letters Patent concurrently herewith; or on _____; or filed an application for United States Letters Patent on _____, (Serial No. _____); and

WHEREAS, ROHM CO., LTD., a corporation of Japan, whose post office address is 21, Saiin-Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto, Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. _____, filed July 9, 2001) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

1. Full Name of Sole of First Assignor Masaki YONEDA	Assignor's Signature <i>Masaki Yoneda</i>	Date June 29, 2001
Address c/o Rohm Co., Ltd., 21, Saiin-Mizosaki-cho, Ukyo-ku, Kyoto-shi, Kyoto, Japan		Citizenship Japan
2. Full Name of Second Assignor	Assignor's Signature	Date
Address		Citizenship
3. Full Name of Third Assignor	Assignor's Signature	Date
Address		Citizenship

MORGAN, LEWIS & BOCKIUS

PATENT

RECORDED: 07/09/2001

REEL: 011973 FRAME: 0833